

Electronic Patent Application Fee Transmittal

Application Number:	09892225			
Filing Date:	25-Jun-2001			
Title of Invention:	Semiconductor device and fabrication method therefor			
First Named Inventor:	Shunpei Yamazaki			
Filer:	John F. Hayden/Tawana N. Lefeged			
Attorney Docket Number:	07977/279001/US5023/5025			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1202	14	50	700
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 1 month with \$0 paid	1251	1	120	120
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				1000